2SAR522M / 2SAR522EB / 2SAR522UB

PNP -200mA -20V General purpose transistor

Datasheet

| Parameter | Value | |
|----------------|--------|--|
| V_{CEO} | -20V | |
| I _C | -200mA | |

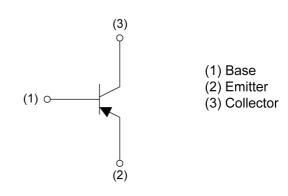
Outline

| SOT-723 | SOT-416FL |
|-----------|-----------|
| (1) (2) | (1) (2) |
| 2SAR522M | 2SAR522EB |
| (VMT3) | (EMT3F) |
| SOT-323FL | |
| (1) | |
| 2SAR522UB | |
| (UMT3F) | |

Features

- 1) General Purpose.
- 2) Complementary NPN Types: 2SCR522M(VMT3)/ 2SCR522EB(EMT3F)/ 2SCR522UB(UMT3F)

•Inner circuit



Application

GENERAL PURPOSE SMALL SIGNAL AMPLIFIER

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|-----------|----------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|---------|
| 2SAR522M | SOT-723 (VMT3) | 1212 | T2L | 180 | 8 | 8000 | PC |
| 2SAR522EB | SOT-416FL (EMT3F) | 1616 | TL | 180 | 8 | 3000 | PC |
| 2SAR522UB | SOT-323FL (UMT3F) | 2021 | TL | 180 | 8 | 3000 | PC |

● Absolute maximum ratings (T_a = 25°C)

| Parameter | | | Values | Unit |
|---------------------------|------------------------------|-------------------|--------|------|
| Collector-base voltage | | | -20 | V |
| Collector-emitter voltage | | | -20 | V |
| Emitter-base voltage | | | -5 | V |
| | | | -200 | mA |
| Collector current | Collector current | | | mA |
| | 2SAR522M | | 150 | |
| Power dissipation | 2SAR522EB | P _D *2 | 150 | mW |
| | | 200 | | |
| Junction temperature | T _j | 150 | °C | |
| Range of storage tempera | Range of storage temperature | | | °C |

● Electrical characteristics (T_a = 25°C)

| Davanastav | Curah al | Conditions | Values | | | l leit |
|--------------------------------------|----------------------|--|------------|------|------|--------|
| Parameter | Symbol Conditions | | Min. | Тур. | Max. | Unit |
| Collector-base breakdown voltage | BV _{CBO} | I _C = -50μA | -20 | - | - | V |
| Collector-emitter breakdown voltage | BV _{CEO} | I _C = -1mA | -20 | - | - | V |
| Emitter-base breakdown voltage | BV _{EBO} | I _E = -50μA | - 5 | 1 | 1 | V |
| Collector cut-off current | I _{CBO} | V _{CB} = -20V | ı | - | -100 | nA |
| Emitter cut-off current | I _{EBO} | V _{EB} = -5V | ı | - | -100 | nA |
| Collector-emitter saturation voltage | V _{CE(sat)} | I _C = -100mA, I _B = -10mA | ı | -120 | -300 | mV |
| DC current gain | h _{FE} | $V_{CE} = -2V, I_{C} = -1mA$ | 120 | - | 560 | - |
| Transition frequency | f _T | V _{CE} = -10V, I _E = 10mA, f = 100MHz | - | 350 | - | MHz |
| Output capacitance | C _{ob} | V _{CB} = -10V, I _E = 0A, f = 1MHz | - | 3.0 | - | pF |

^{*1} Pw=10ms Single Pulse

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves(T_a = 25°C)

Fig.1 Ground Emitter Propagation

Characteristics

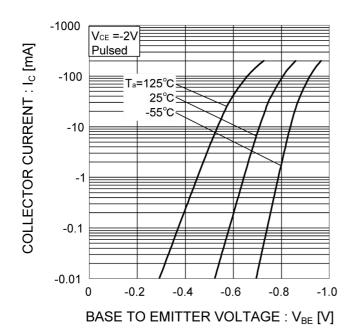
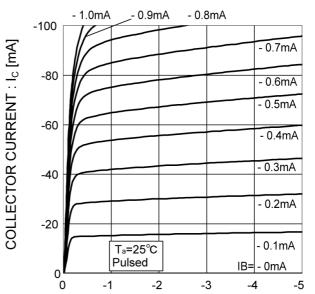


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

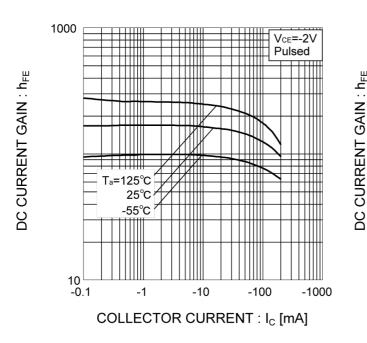
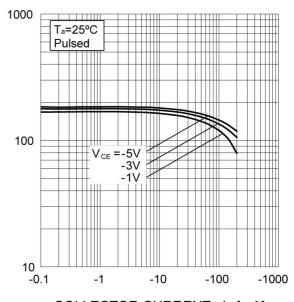


Fig.4 DC Current Gain vs. Collector Current (II)



COLLECTOR CURRENT : I_C [mA]

● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

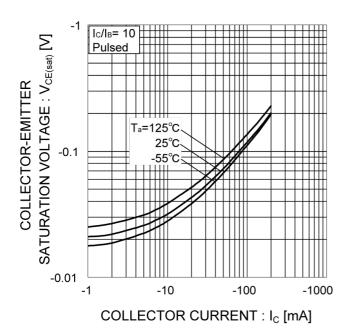
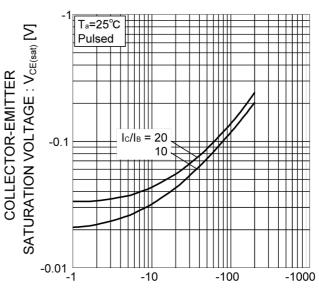


Fig.6 Collector-Emitter Saturation

Voltage vs. Collector Current (II)



COLLECTOR CURRENT : I_C [mA]

Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

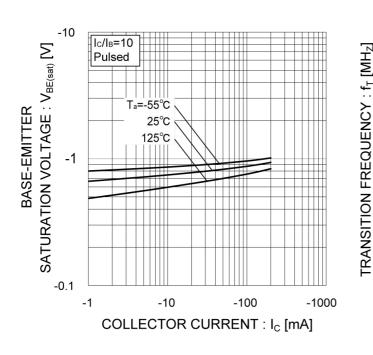
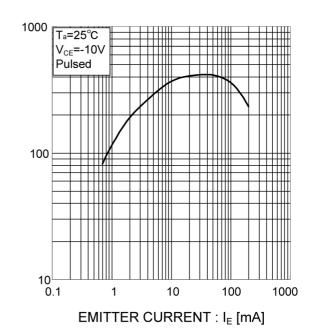


Fig.8 Gain Bandwidth Product vs.

Emitter Current



◆Electrical characteristic curves(T_a = 25°C)

Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

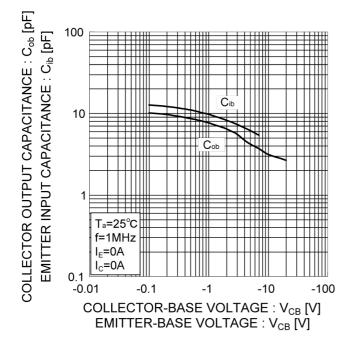


Fig.10 Safe Operating Area

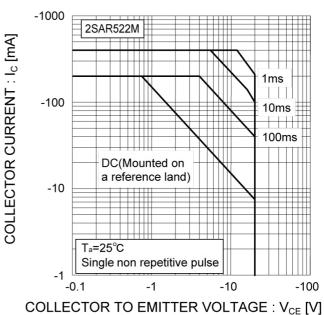


Fig.11 Safe Operating Area

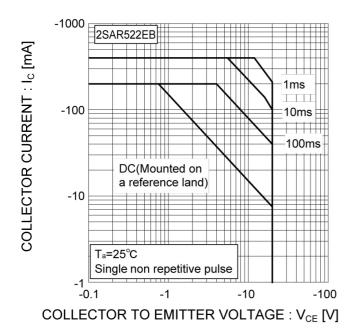
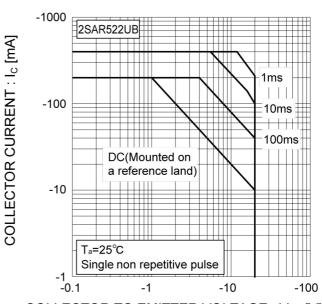
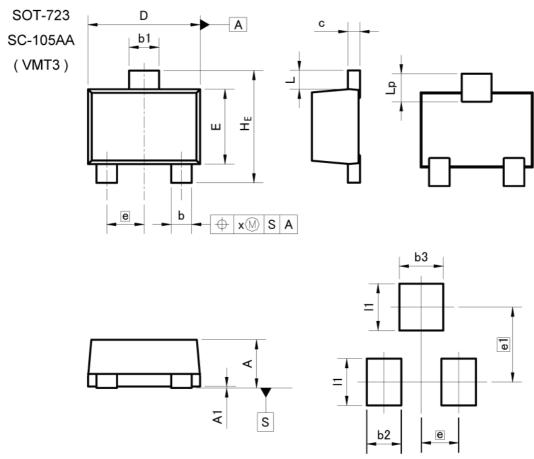


Fig.12 Safe Operating Area



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

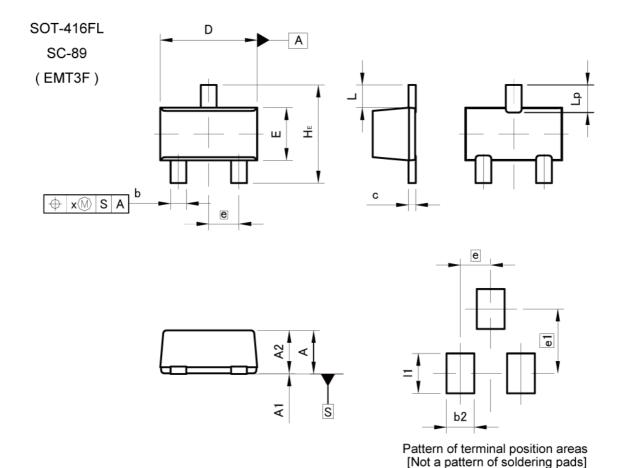
| DIM | DIM MILIME | | INC | HES |
|-----|------------|------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 0.45 | 0.55 | 0.018 | 0.022 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| b | 0.17 | 0.27 | 0.007 | 0.011 |
| b1 | 0.27 | 0.37 | 0.011 | 0.015 |
| С | 0.08 | 0.18 | 0.003 | 0.007 |
| D | 1.10 | 1.30 | 0.043 | 0.051 |
| E | 0.70 | 0.90 | 0.028 | 0.035 |
| е | 0.4 | 40 | 0.0 | 02 |
| HE | 1.10 | 1.30 | 0.043 | 0.051 |
| L | 0.10 | 0.30 | 0.004 | 0.012 |
| Lp | 0.20 | 0.40 | 0.008 | 0.016 |
| х | - | 0.10 | - | 0.004 |

| DIM | | MILIMETERS | | INCHES | | |
|-----|----|------------|------|--------|-------|--|
| | | MIN | MAX | MIN | MAX | |
| | b2 | 1 | 0.37 | ı | 0.015 | |
| | b3 | 1 | 0.47 | - | 0.019 | |
| | e1 | 0.80 | | 0.0 | 31 | |
| | 11 | - 0.50 | | _ | 0.020 | |

Dimension in mm/inches



Dimensions



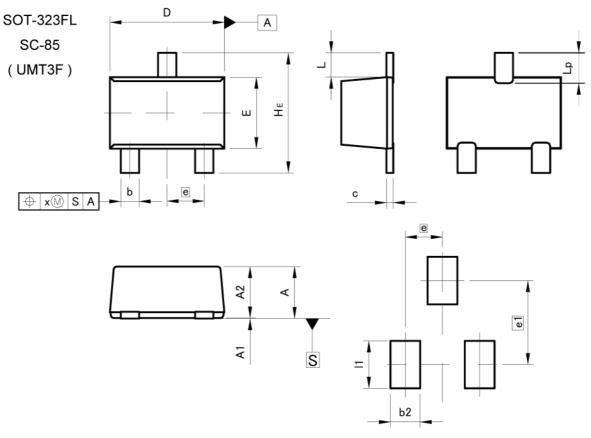
MILIMETERS INCHES DIM MIN MAX MIN MAX 0.85 0.033 0.65 0.026 Α A1 0.00 0.10 0.000 0.004 0.60 0.80 0.024 0.031 A2 b 0.21 0.36 0.008 0.014 0.007 0.08 0.18 0.003 С D 1.50 1.70 0.059 0.067 0.76 0.96 0.030 Е 0.038 0.50 0.020 е HE 1.50 1.70 0.059 0.067 0.37 0.015 L 0.35 0.55 0.014 0.022 Lр 0.10 0.004 X

| DIM | MILIMETERS | | INCHES | | |
|------|------------|------|--------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| b2 | _ | 0.46 | _ | 0.018 | |
| e1 | _ | 1.05 | _ | 0.041 | |
| - 11 | - | 0.65 | - | 0.026 | |

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| | MILIMETERS INCLIES | | | | |
|-----|--------------------|------|--------|-------|--|
| DIM | MILIMETERS | | INCHES | | |
| DIW | MIN | MAX | MIN | MAX | |
| Α | 0.85 | 1.05 | 0.033 | 0.041 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| A2 | 0.80 | 1.00 | 0.031 | 0.039 | |
| b | 0.27 | 0.42 | 0.011 | 0.017 | |
| С | 0.08 | 0.18 | 0.003 | 0.007 | |
| D | 1.90 | 2.10 | 0.075 | 0.083 | |
| E | 1.15 | 1.35 | 0.045 | 0.053 | |
| е | 0. | 65 | 0.026 | | |
| HE | 2.00 | 2.20 | 0.079 | 0.087 | |
| L | 0. | 43 | 0.0 | 17 | |
| Lp | 0.43 | 0.63 | 0.017 | 0.025 | |
| х | - | 0.10 | - | 0.004 | |

| DIM | MILIMETERS | | INCHES | | |
|-----|------------|-----|--------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| b2 | b2 – 0.52 | | _ | 0.020 | |
| e1 | 1.47 | | 0.0 | 58 | |
| 11 | - 0.83 | | = | 0.033 | |

Dimension in mm/inches



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|----------|----------|------------|--------|
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